

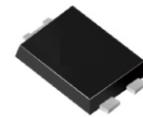
CDBHA10200LR-HF

Reverse Voltage: 200V

Forward Current: 10A

RoHS Device

Halogen Free



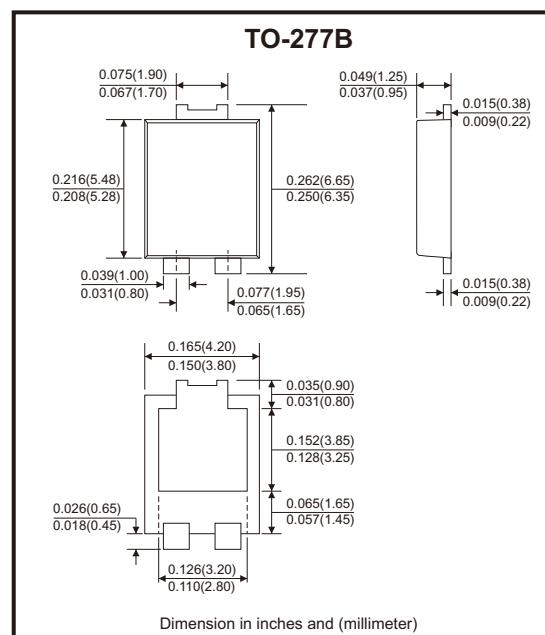
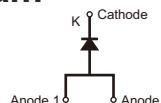
Features

- Metal silicon junction, majority carrier conduction.
- Guard ring for overvoltage protection.
- Low power loss, high efficiency.
- High current capability, low forward voltage drop.
- High surge capability.
- Ideal for automated placement.

Mechanical data

- Case: TO-277B, molded plastic.
- Terminals: Plated axial leads, solderable per MIL-STD-750, method 2026.
- Polarity: Indicated by cathode band.
- Mounting position: Any.

Circuit Diagram



Maximum Ratings (at TA=25°C, unless otherwise noted)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	200	V
Maximum average forward rectified current	I _{F(AV)}	10	A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated T _L)	I _{FSM}	250	A
Typical thermal resistance (Note 1)	R _{θJA}	60	°C/W
	R _{θJL}	3	
Operating junction temperature range	T _J	-55 to +150	°C
Storage temperature range	T _{STG}	-55 to +150	°C

Notes: 1. Units mounted on recommended PCB 1 oz. Pad layout.

Electrical Characteristics (at TA=25°C, unless otherwise noted)

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit	
Instantaneous forward voltage (Note 1)	I _F = 10A	V _F	T _A = 25°C	0.79	0.82	V	
			T _A = 100°C	0.68			
			T _A = 125°C	0.65			
	I _F = 5A		T _A = 25°C	0.73			
			T _A = 100°C	0.61			
			T _A = 125°C	0.57			
Reverse current (Note 2)	V _R = 200V	I _R	T _A = 25°C	5	20	µA	
			T _A = 100°C		0.3	mA	
			T _A = 125°C		1.5		
Typical junction capacitance	V _R = 4V, f = 1MHz	C _J		290		pF	

Notes: 1. Pulse test: 300µs pulse width, 1% duty cycle.

2. Pulse test: pulse width ≤ 40ms.

Ultra Low VF Schottky Barrier Rectifiers

Comchip
SMD Diode Specialist

Rating and Characteristics Curves (CDBHA10200LR-HF)

Fig.1 - Forward Current Derating Curve

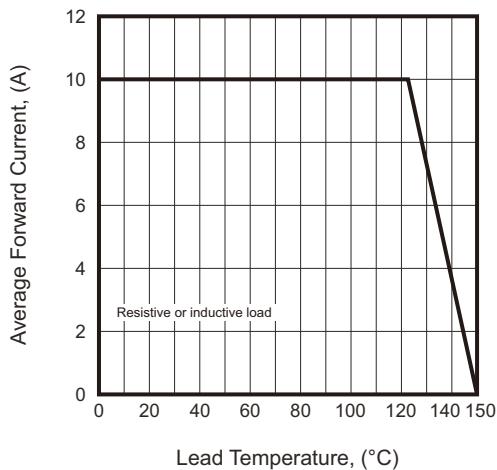


Fig.2 - Maximum Non-Repetitive Peak Forward Surge Current

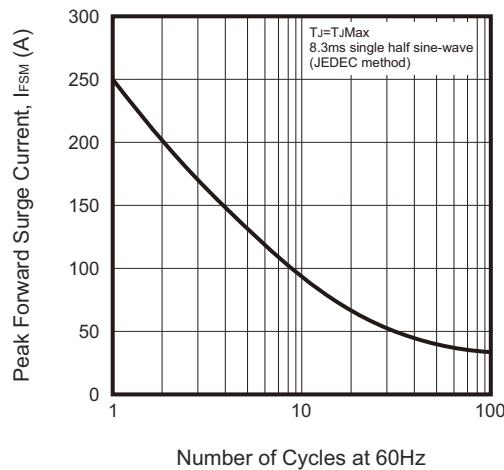


Fig.3 - Typical Instantaneous Forward Characteristics

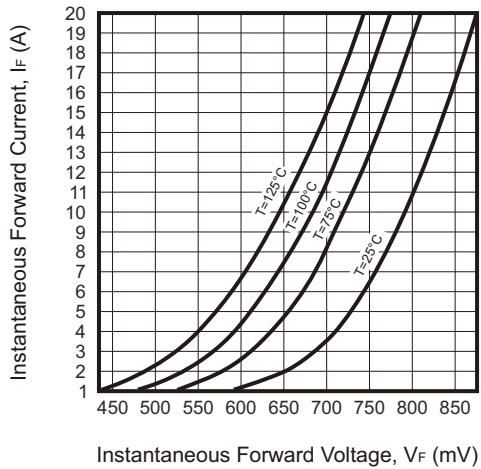


Fig.4 - Typical Reverse Characteristics

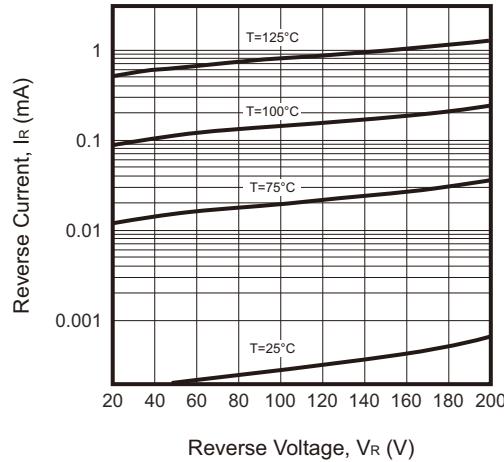
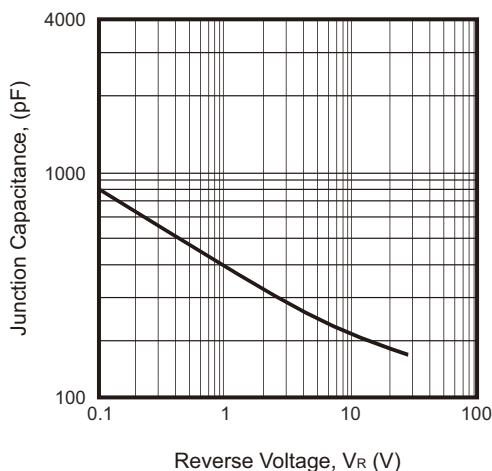
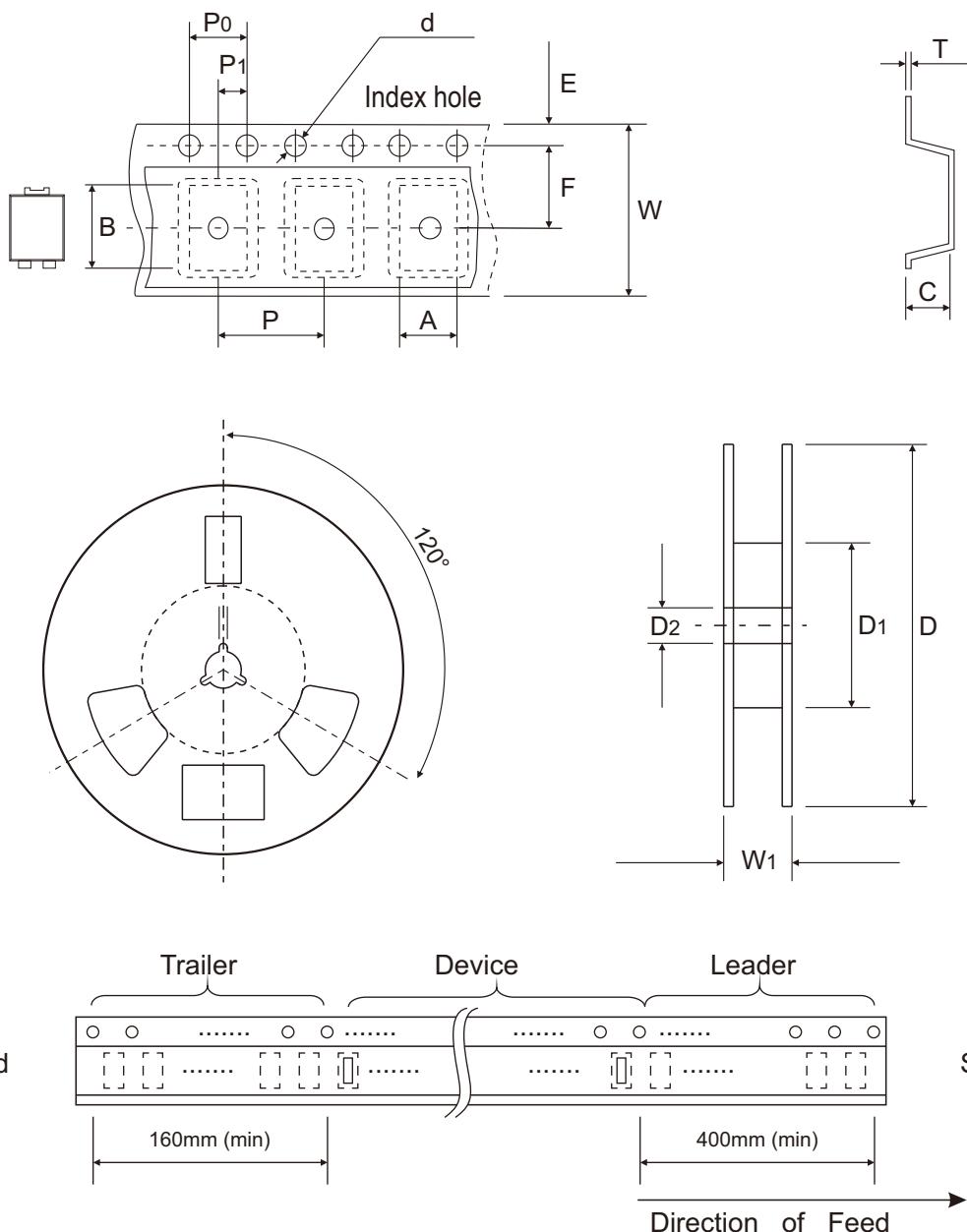


Fig.5 - Typical Junction Capacitance



Reel Taping Specification



TO-277B	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	4.38 ± 0.10	6.90 ± 0.10	4.00 ± 0.10	1.55 ± 0.05	330 ± 2.00	75.00 ± 1.00	13.30 ± 0.30
	(inch)	0.172 ± 0.004	0.272 ± 0.004	0.157 ± 0.004	0.061 ± 0.002	12.992 ± 0.079	2.953 ± 0.039	0.524 ± 0.012

TO-277B	SYMBOL	E	F	P	P0	P1	T	W	W1
	(mm)	1.75 ± 0.10	7.50 ± 0.10	8.00 ± 0.07	4.00 ± 0.07	2.00 ± 0.07	0.30 ± 0.05	16.00 ± 0.20	16.40 ± 0.50
	(inch)	0.069 ± 0.004	0.295 ± 0.004	0.315 ± 0.003	0.157 ± 0.003	0.079 ± 0.003	0.012 ± 0.002	0.630 ± 0.008	0.646 ± 0.020

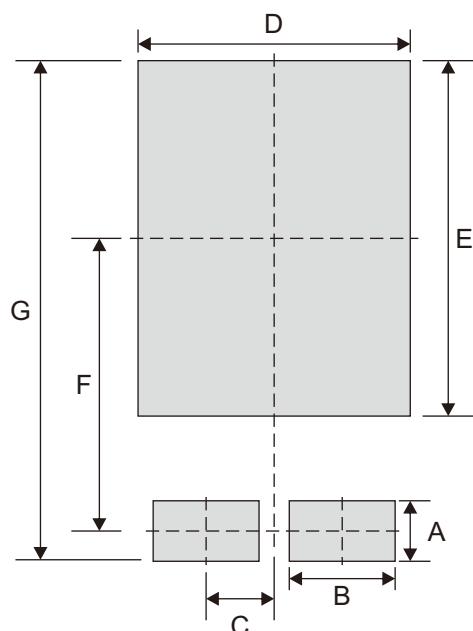
Marking Code

Part Number	Marking Code
CDBHA10200LR-HF	SP10U200UL



Suggested P.C.B. PAD Layout

SIZE	TO-277B	
	(mm)	(inch)
A	0.80	0.031
B	1.40	0.055
C	0.90	0.035
D	3.60	0.142
E	4.70	0.185
F	3.87	0.152
G	6.60	0.260



Standard Packaging

Case Type	REEL PACK	
	REEL (pcs)	Reel Size (inch)
TO-277B	5,000	13